

PTC thermistors for overcurrent protection

SMDs, EIA sizes 0402, 0603, and 1210, 24 V \ldots 230 V

Series/Type:

Date: August 2014

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SMDs, EIA sizes 0402, 0603, and 1210, 24 V ... 230 V

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Applications

- Overcurrent protection
- Short circuit protection

Features

- Qualification based on AEC-Q200 rev. D for type A407, A607 and A907
- Thermistor chip with lead-free tinned terminations
- Small size
- Short response times
- Suitable for reflow soldering only
- Suitable for automatic placement
- UL approval for selected types (case size 1210)
- RoHS-compatible

Delivery mode

Blister tape (case size 1210) or cardboard tape (case sizes 0402 and 0603), 180-mm reel with 8-mm tape, taping to IEC 60286-3

General technical data

Switching cycles		Ν	100	
Tolerance of R _R	(except A907)	ΔR_{R}	±25	%
Tolerance of R _R	(for A907)	ΔR_{R}	±35	%
Operating temperature range	(V = 0)	T _{op}	-40/+125	°C
Operating temperature range	(V \leq V _{max} , except A407 and A907)	T _{op}	-20/+85	°C
Operating temperature range	$(V \le V_{max}, for A407)$	T _{op}	-40/+125	°C
Operating temperature range	(V \leq V _{max} , for A907)	T _{op}	-40/+85	°C

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Electrical specifications and ordering codes

Туре	I _R ¹⁾	I _S ¹⁾	I _{Smax}	R _R	R_{min}	EIA	Approvals	Ordering code
			$(V = V_{max})$			case		
	mA	mA	А	Ω	Ω	size	F/	
$V_{max} = 30 \text{ V DC or V AC}, V_{R} = 24 \text{ V DC or V AC}$								
A606	90	180	0.5	27	17	1210	Х	B59606A0110A062
A607	70	130	0.4	55	30	1210	х	B59607A0120A062
$V_{max} = 3$	2 V DC	or V AC, V	$V_{\rm R} = 24 \text{ V DC}$	or V A	0			
A407	13	32	0.12	470	265	0402	-	B59407A0115A062
$V_{max} = 60 \text{ V DC or V AC}, V_{R} = 42 \text{ V DC or V AC}$								
A622	20	40	0.22	220	150	0603	-	B59622A0090A062
$V_{max} = 80 \text{ V DC or V AC}, V_{R} = 63 \text{ V DC or V AC}$								
A623	13	25	0.15	470	300	0603	_	B59623A0090A062
A707	50	90	0.3	125	75	1210	х	B59707A0120A062
$V_{max} = 265 \text{ V DC or V AC}, V_R = 230 \text{ V DC or V AC}$								
A807	15	40	0.2	400	200	1210	Х	B59807A0090A062
A907	12	22	0.15	1500	640	1210	х	B59907A0120B062
V _{max} = 400 V DC or V AC, V _R = 230 V DC or V AC								
A907	12	22	0.15	1500	640	1210	-	B59907A0120A062

1) Measured on component soldered to standardized PCB

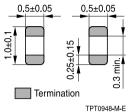
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Dimensional drawings in mm

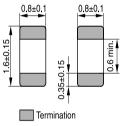
EIA case size 0402



Solder pad

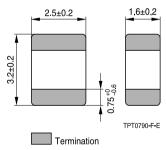


EIA case size 0603



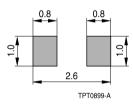
TPT0698-5-E

EIA case size 1210



Recommended maximum dimensions (mm)

Solder pad



Solder pad

Please read *Cautions and warnings* and *Important notes* at the end of this document.

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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature, I _{Smax} ; V _{max}	< 25%
cycling		Number of cycles: 100	< 10% ¹⁾
Electrical endurance,	IEC 60738-1	Storage at V _{max} /T _{op,max} (V _{max})	< 25%
constant		Test duration: 1000 h	< 20%1)
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_1 = T_{op,min} (0 V), T_2 = T_{op,max} (0 V)$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration	IEC 60738-1	Frequency range: 10 - 55 - 10 Hz	< 5%
		Displacement amplitude: 0.75 mm	< 10% ¹⁾
		Test duration: 3×2 h	
		Test according to IEC 60068-2-6, test Fc	
Shock	IEC 60738-1	Pulse shape: half-sine	< 5%
		Acceleration: 400 m/s ²	< 10% ¹⁾
		Pulse duration: 6 ms; 6 x 5000 pulses	
		Test according to IEC 60068-2-27, test Ea	
Climatic sequence	IEC 60738-1	Dry heat: $T = T_{op,max} (0 V)$	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T = T_{op,min} (0 V)$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	
Bending test	IEC 60738-1	Components reflow-soldered to test board	< 10%
		Maximum bending: 2 mm	
		Test according to IEC 60068-2-21, test Ue	
Adhesive strength on		Shearing of the component soldered on	No visible
PCB		PCB by a force of 5 N normal to	damage
		components longitudinal axis	

1) For type A407, B59407A0115A062

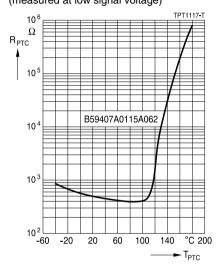
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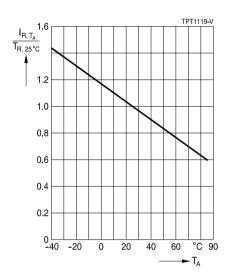
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Characteristics (typical) for A407

PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)



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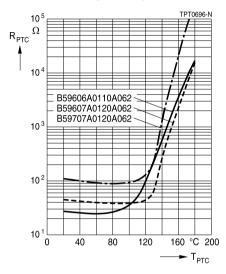
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Characteristics (typical) for A606, A607 and A707

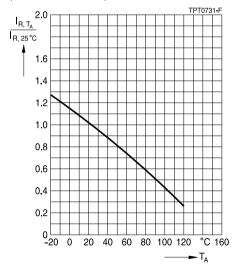
PTC resistance R_{PTC} versus

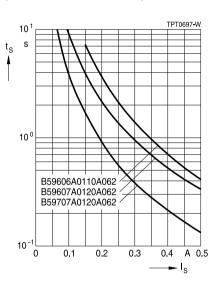
PTC temperature T_{PTC}

(measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)





Overcurrent protection

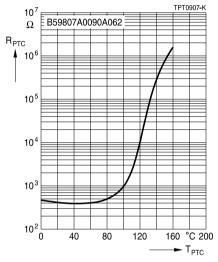
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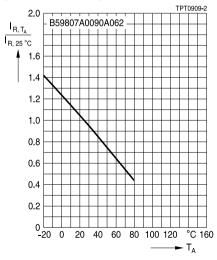
Characteristics (typical) for A807

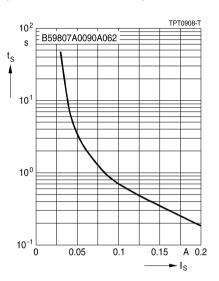
PTC resistance R_{PTC} versus PTC temperature T_{PTC}

(measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)





Overcurrent protection

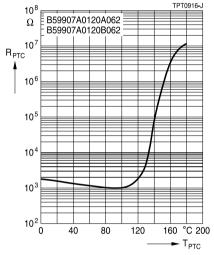
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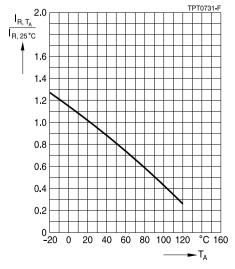
Characteristics (typical) for A907

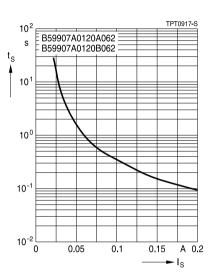
PTC resistance R_{PTC} versus PTC temperature T_{PTC}

(measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)





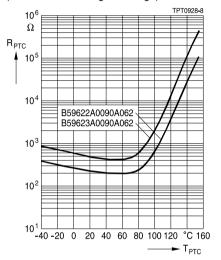
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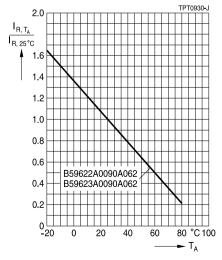
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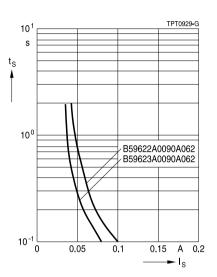
Characteristics (typical) for A622 and A623

PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)



Rated current I_{R} versus ambient temperature T_{A} (measured in still air)





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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.

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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).

This listing does not claim to be complete, but merely reflects the experience of EPCOS AG.

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Symbols and terms

Symbol	Term
A	Area
С	Capacitance
C _{th}	Heat capacity
f	Frequency
I	Current
I _{max}	Maximum current
I _R	Rated current
I _{res}	Residual current
I _{PTC}	PTC current
l _r	Residual currrent
I _{r,oil}	Residual currrent in oil (for level sensors)
I _{r,air}	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
I _s	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
Ν	Number (integer)
N _c	Operating cycles at V _{max} , charging of capacitor
N _f	Switching cycles at V _{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P _{el}	Electrical power
P_{diss}	Dissipation power
R _G	Generator internal resistance
R _{min}	Minimum resistance
R _R	Rated resistance
ΔR_R	Tolerance of R _R
R _P	Parallel resistance
R _{PTC}	PTC resistance
R _{ref}	Reference resistance
R _s	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25} T	Tolerance of R ₂₅
	Temperature
t T	Time
T _A	Ambient temperature



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t _a	Thermal threshold time
T _c	Ferroelectric Curie temperature
t _E	Settling time (for level sensors)
T _R	Rated temperature
T _{sense}	Sensing temperature
T _{op}	Operating temperature
T _{PTC}	PTC temperature
t _R	Response time
T _{ref}	Reference temperature
T _{Rmin}	Temperature at minimum resistance
t _s	Switching time
T _{surf}	Surface temperature
UCT	Upper category temperature
V or V_{el}	Voltage (with subscript only for distinction from volume)
$V_{c(max)}$	Maximum DC charge voltage of the surge generator
$V_{F,max}$	Maximum voltage applied at fault conditions in protection mode
V _{RMS}	Root-mean-square value of voltage
V _{BD}	Breakdown voltage
V_{ins}	Insulation test voltage
$V_{link,max}$	Maximum link voltage
V _{max}	Maximum operating voltage
$V_{\text{max,dyn}}$	Maximum dynamic (short-time) operating voltage
V _{meas}	Measuring voltage
V _{meas,max}	Maximum measuring voltage
V _R	Rated voltage
V _{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
$\delta_{ ext{th}}$	Dissipation factor
$ au_{th}$	Thermal cooling time constant
λ	Failure rate
е	Lead spacing (in mm)

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